# INTEGRATED CIRCUITS

# DATA SHEET

74F242
Quad transceiver, inverting (3-State)
74F243
Quad transceiver (3-State)

Product specification

1990 Aug 31

IC15 Data Handbook

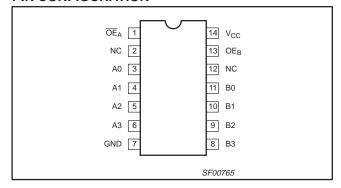




Transceivers 74F242/74F243

74F242 Quad Transceiver, Inverting (3-State) 74F243 Quad Transceiver (3-State)

## **PIN CONFIGURATION**



TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F242	4.3ns	31.2mA
74F243	4.0ns	66mA

## **ORDERING INFORMATION**

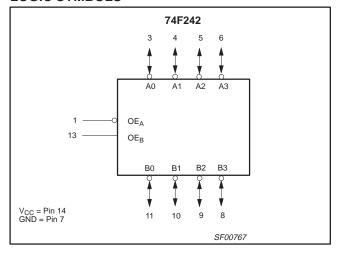
DESCRIPTION	COMMERCIAL RANGE $V_{CC}$ = 5V $\pm 10\%$ , $T_{amb}$ = 0°C to +70°C	PKG DWG #		
14-pin plastic DIP	N74F242N, N74F243N	SOT27-1		
14-pin plastic SO	N74F242D, N74F243D	SOT108-1		

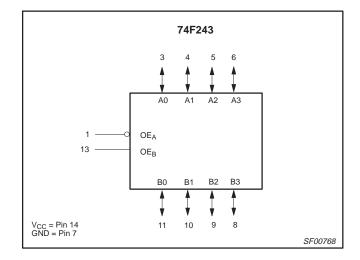
## INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
An, Bn	Data inputs (74F242)	3.5/1.67	70μA/1.0mA
An, Bn	Data inputs (74F243)	3.5/2.67	70μA/1.6mA
<del>OE</del> <sub>A</sub>	Output enable input (active Low)	1.0/1.67	20μA/1.0mA
OE <sub>B</sub>	Output enable input	1.0/1.67	20μA/1.0mA
An, Bn	Data outputs	750/106.7	15mA/64mA

**NOTE:** One (1.0) FAST unit load is defined as: 20μA in the High state and 0.6mA in the Low state.

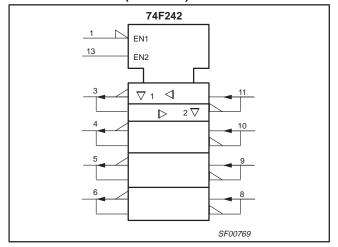
## **LOGIC SYMBOLS**

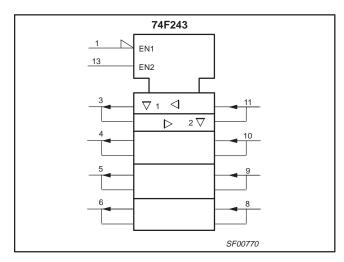


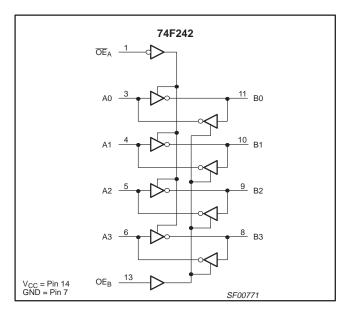


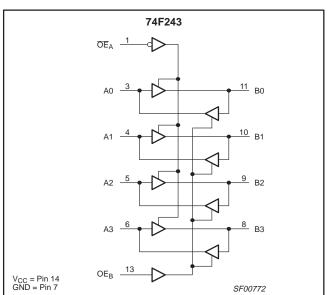
#### **Transceivers** 74F242/74F243

# LOGIC SYMBOLS (IEEE/IEC)









# **LOGIC DIAGRAMS FUNCTION TABLE, 74F242**

INP	JTS	OUTPUTS				
ŌĒĄ	OE <sub>B</sub>	An	Bn			
L	L	INPUT	B= <del>A</del>			
Н	L	Z	Z			
L	Н	а	а			
Н	Н	A=B	INPUT			

H = High voltage level

L = Low voltage level

Z = High impedance "off" state a = This condition is not allowed due to excessive currents

# **FUNCTION TABLE, 74F243**

INPL	JTS	OUTF	PUTS		
<del>OE</del> <sub>A</sub>	OEB	An	Bn		
L	L	INPUT	B=A		
Н	L	Z	Z		
L	Н	а	а		
Н	Н	A=B	INPUT		

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## **ABSOLUTE MAXIMUM RATINGS**

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V <sub>CC</sub>	Supply voltage	-0.5 to +7.0	V
V <sub>IN</sub>	Input voltage	-0.5 to +7.0	V
I <sub>IN</sub>	Input current	−30 to +5	mA
V <sub>OUT</sub>	Voltage applied to output in High output state	−0.5 to V <sub>CC</sub>	V
I <sub>OUT</sub>	Current applied to output in Low output state	128	mA
T <sub>amb</sub>	Operating free-air temperature range	0 to +70	°C
T <sub>stg</sub>	Storage temperature	-65 to +150	°C

## **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER		UNIT		
STWIBUL	PARAMETER	MIN	NOM	MAX	UNII
V <sub>CC</sub>	Supply voltage	4.5	5.0	5.5	V
V <sub>IH</sub>	High-level input voltage	2.0			V
V <sub>IL</sub>	Low-level input voltage			0.8	V
I <sub>IK</sub>	Input clamp current			-18	mA
I <sub>OH</sub>	High-level output current			-15	mA
I <sub>OL</sub>	Low-level output current			64	mA
T <sub>amb</sub>	Operating free-air temperature range	0		70	°C

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#### DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	DADAME	ren.			CT CONDITION	D1		LIMITS		UNIT
SYMBOL	PARAMET	IER		"	TEST CONDITIONS <sup>1</sup>				MAX	UNII
	$V_{CC} = MIN,$ $V_{IL} = MAX,$ $V_{IH} = MIN$ $I_{OH} = -3m$		. OA	±10%V <sub>CC</sub>	2.4			V		
				$I_{OH} = -3mA$	±5%V <sub>CC</sub>	2.7	3.3		V	
V <sub>OH</sub>	High-level output voltage	)		$V_{CC} = MIN,$ $V_{IL} = MAX,$	45	±10%V <sub>CC</sub>	2.0	3.2		V
				$V_{IH} = MIN$	$I_{OL} = -15 \text{mA}$	±5%V <sub>CC</sub>	2.0	3.1		ľ
M	Low lovel output voltage			$V_{CC} = MIN,$ $V_{IL} = MAX,$	I MAN	±10%V <sub>CC</sub>			0.55	V
V <sub>OL</sub>	Low-level output voltage			$V_{IH} = MIN$	I <sub>OH</sub> =MAX	±5%V <sub>CC</sub>		0.42	0.55	V
$V_{IK}$	Input clamp voltage			$V_{CC} = MIN, I_I$	= I <sub>IK</sub>			-0.73	-1.2	V
l.	Input current at	at A0–A3, B0–B3		V <sub>CC</sub> = MAX, '	V <sub>I</sub> = 5.5V				1	mA
†I	maximum input voltage	ΘE <sub>A</sub> ,	OE <sub>B</sub>	$V_{CC} = MAX, V_I = 7.0V$					100	μΑ
I <sub>IH</sub>	High-level input current	OE <sub>A</sub> ,	OE <sub>B</sub>	$V_{CC} = MAX, VI = 2.7V$					20	μΑ
I <sub>IL</sub>	Low-level input current	on	only $V_{CC} = MAX, VI = 0.5V$					-1	mA	
I <sub>IH</sub> +I <sub>OZH</sub>	Off-state output current High-level voltage applie	ed		V <sub>CC</sub> = MAX, '	V <sub>O</sub> = 2.7V				70	μА
	Off-state output current Low-level voltage	74F2	242	V 846V )	0.51/				-1.0	^
I <sub>IL</sub> +I <sub>OZL</sub>	applied	74F2	243	$V_{CC} = MAX, Y$	v <sub>O</sub> = 0.5v				-1.6	mA
I <sub>OS</sub>	Short-circuit output curre	ent <sup>3</sup>		$V_{CC} = MAX$			-100		-225	mA
			Іссн					22	35	mA
		74F242	I <sub>CCL</sub>	$V_{CC} = MAX$				40	55	mA
l	Supply current (total)		I <sub>CCZ</sub>	<u> </u>				32	45	mA
Icc	Supply current (total)	I <sub>CCH</sub>						64	80	mA
		74F243 I <sub>CCL</sub>	I <sub>CCL</sub>	V <sub>CC</sub> = MAX				64	90	mA
			I <sub>CCZ</sub>					71	90	mA

#### NOTES:

- 1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- 2. All typical values are at  $V_{CC} = 5V$ ,  $T_{amb} = 25^{\circ}C$ .
- 3. Not more than one output should be shorted at a time. For testing I<sub>OS</sub>, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.

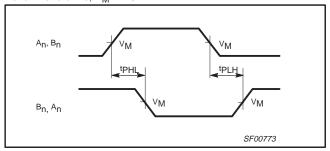
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## **AC ELECTRICAL CHARACTERISTICS**

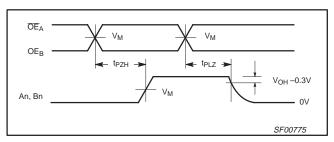
						LIM	ITS		
SYMBOL	PARAMETER	TEST CONDITION	$V_{CC}$ = +5V $T_{amb}$ = +25°C $C_L$ = 50pF, $R_L$ = 500 $\Omega$			V <sub>CC</sub> = +5 T <sub>amb</sub> = 0°C C <sub>L</sub> = 50pF,	UNIT		
				MIN	TYP	MAX	MIN	MAX	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An, Bn to Bn, An		Waveform NO TAG	2.5 2.0	3.5 3.0	6.0 4.5	2.5 2.0	7.0 4.5	ns
t <sub>PZH</sub>	Output Enable time to High or Low level	74F242	Waveform 3 Waveform 4	3.0 3.5	4.0 6.5	7.0 9.0	3.0 3.5	8.0 10.5	ns
t <sub>PHZ</sub>	Output Disable time from High or Low level		Waveform 3 Waveform 4	3.5 3.5	5.5 6.0	8.5 9.5	3.5 3.5	9.0 11.0	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An, Bn to Bn, An		Waveform 2	2.5 2.5	4.0 4.0	5.2 5.2	2.0 2.0	6.2 6.5	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Output Enable time to High or Low level	74F243	Waveform 3 Waveform 4	2.0 2.0	4.5 5.0	5.7 7.5	2.0 2.0	6.7 8.5	ns
t <sub>PHZ</sub>	Output Disable time from High or Low level		Waveform 3 Waveform 4	2.0 2.0	4.0 4.5	6.0 6.0	2.0 2.0	7.0 7.0	ns

# **AC WAVEFORMS**

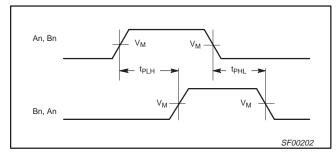
For all waveforms,  $V_M = 1.5V$ .



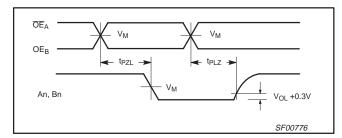
Waveform 1. For Inverting Outputs



Waveform 3. 3-State Output Enable Time to High Level and Output Disable Time from High Level



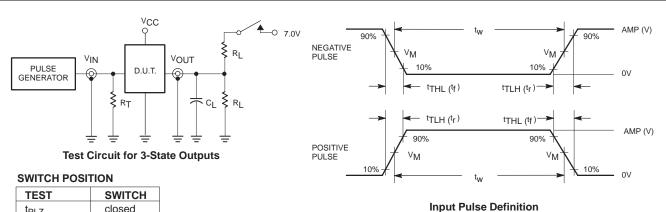
Waveform 2. For Non-Inverting Outputs



Waveform 4. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

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## **TEST CIRCUIT AND WAVEFORMS**



SWITCH
closed
closed
open

## **DEFINITIONS:**

R<sub>L</sub> = Load resistor;

see AC electrical characteristics for value.

Load capacitance includes jig and probe capacitance;
see AC electrical characteristics for value.

Termination resistance should be equal to  $Z_{\text{OUT}}$  of pulse generators.  $R_T =$ 

family	INP	UT PU	LSE REQU	REMEN	TS	
family	amplitude	$V_{\text{M}}$	rep. rate	t <sub>w</sub>	t <sub>TLH</sub>	t <sub>THL</sub>
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns

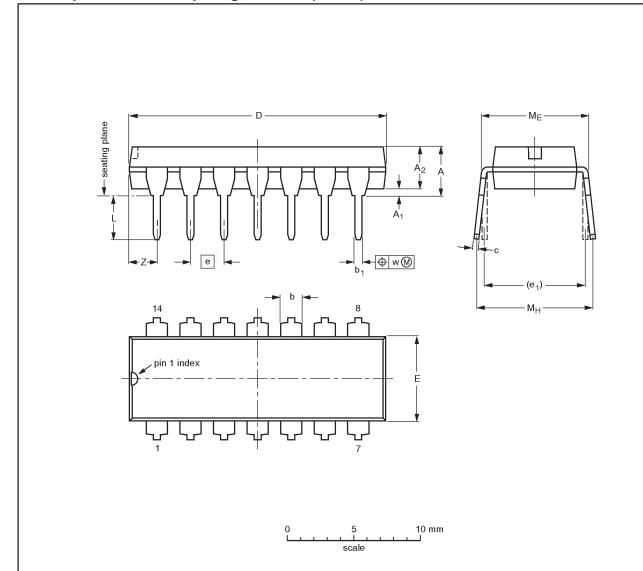
SF00777

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# DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



## DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

#### Note

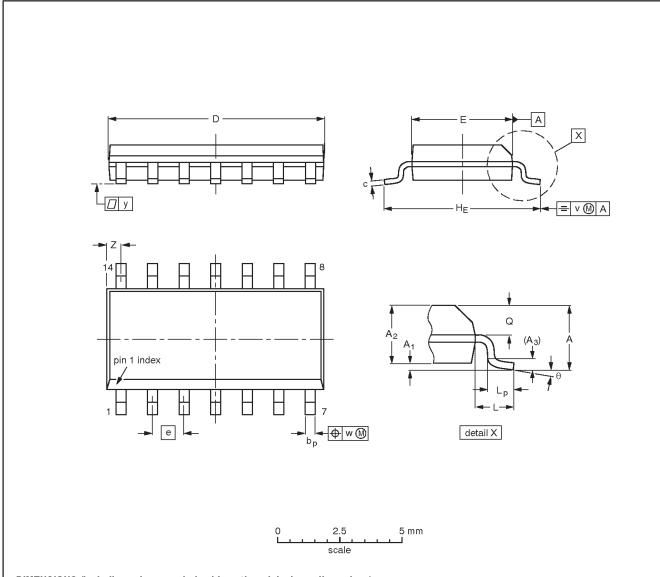
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE	E
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	ı
SOT27-1	050G04	MO-001AA			<del>92-11-17</del> 95-03-11	

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# SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



## DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	А3	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075		0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

## Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT108-1	076E06S	MS-012AB			<del>95-01-23</del> 97-05-22

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#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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<sup>[1]</sup> Please consult the most recently issued datasheet before initiating or completing a design.

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